

Title (en)  
HEAT SOURCE DEVICE AND HEAT SOURCE SYSTEM PROVIDED WITH HEAT SOURCE DEVICE

Title (de)  
WÄRMEQUELLENVORRICHTUNG UND WÄRMEQUELLENSYSTEM MIT DER WÄRMEQUELLENVORRICHTUNG

Title (fr)  
DISPOSITIF DE SOURCE DE CHALEUR ET SYSTÈME DE SOURCE DE CHALEUR DOTÉ D'UN DISPOSITIF DE SOURCE DE CHALEUR

Publication  
**EP 3165849 A1 20170510 (EN)**

Application  
**EP 14896571 A 20140702**

Priority  
JP 2014067620 W 20140702

Abstract (en)  
A heat source device having a refrigeration cycle in which a compressor, a heat source heat exchanger, an expansion valve, and a heat medium heat exchanger are connected, the heat source device includes a heat exchange chamber that houses at least the heat source heat exchanger and a mechanical chamber that houses at least the compressor and the heat medium heat exchanger. A heat medium pipe is connected to the heat medium heat exchanger, one end of the heat medium pipe is located inside the mechanical chamber, and the other end of the heat medium pipe is located outside the mechanical chamber.

IPC 8 full level  
**F25B 1/00** (2006.01); **F24F 1/28** (2011.01); **F24F 1/30** (2011.01); **F25B 13/00** (2006.01); **F25B 29/00** (2006.01)

CPC (source: EP)  
**F24F 1/022** (2013.01); **F24F 1/28** (2013.01); **F24F 1/30** (2013.01); **F24F 2221/36** (2013.01)

Designated contracting state (EPC)  
AL AT BE BG CH CY CZ DE DK EE ES FI FR GB GR HR HU IE IS IT LI LT LU LV MC MK MT NL NO PL PT RO RS SE SI SK SM TR

Designated extension state (EPC)  
BA ME

DOCDB simple family (publication)  
**EP 3165849 A1 20170510; EP 3165849 A4 20180221; EP 3165849 B1 20230426**; CN 106461276 A 20170222; JP 6310077 B2 20180411;  
JP WO2016002023 A1 20170427; WO 2016002023 A1 20160107

DOCDB simple family (application)  
**EP 14896571 A 20140702**; CN 201480079900 A 20140702; JP 2014067620 W 20140702; JP 2016530742 A 20140702